

**TRADEMARK ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	RELEASE BY SECURED PARTY		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
Bank One NA		07/31/2007	National Association: UNITED STATES
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	DIACOM CORPORATION		
<b>Street Address:</b>	5 Howe Drive		
<b>City:</b>	Amherst		
<b>State/Country:</b>	NEW HAMPSHIRE		
<b>Postal Code:</b>	03031		
<b>Entity Type:</b>	CORPORATION: DELAWARE		
<b>PROPERTY NUMBERS Total: 2</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
Registration Number:	2253071	DIA-SOFT	
Registration Number:	2650690	FAB-AIR	
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>	(202)223-2085		
	<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
<b>Phone:</b>	202 861 3867		
<b>Email:</b>	dctrademarks@dlapiper.com		
<b>Correspondent Name:</b>	Ryan C. Compton		
<b>Address Line 1:</b>	1200 Nineteenth Street, NW		
<b>Address Line 4:</b>	Washington, DISTRICT OF COLUMBIA 20036		
<b>ATTORNEY DOCKET NUMBER:</b>	340415-900000		
<b>NAME OF SUBMITTER:</b>	Ryan C. Compton		
<b>Signature:</b>	/Ryan C. Compton/		

OP \$65.00 2253071

Date:

08/30/2007

**Total Attachments: 3**

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## RELEASE OF INTELLECTUAL PROPERTY SECURITY INTEREST

This Release of Intellectual Property Security Interest (this "**Release**") is dated as of July 31, 2007. Reference is hereby made to the Intellectual Property Security Agreement dated as of ~~April 19, 2004~~ (the "**Agreement**"), by and between Diacom Corporation, a Delaware corporation (the "**Assignor**") and Bank One NA, a national association as administrative, payment and collateral agent for itself and other certain lenders (the "**Assignee**"), and recorded with the United States Patent and Trademark Office on July 9, 2004, at Reel/Frame No. 2889/0546 and at Reel/Frame 14830/0791.

Assignee hereby notifies, acknowledges to and agrees with Assignor that the security interest granted by Assignor in the Intellectual Property (as defined in the Agreement) (the "**IP Collateral**") including, without limitation, the security interest granted in the Patents, Marks, Unregistered Proprietary Rights, Internet Domain Names and Licenses listed on the attached Schedule 1, is terminated and released, and that Assignee hereby releases and forever discharges all of its right, title and interest of any kind or nature in the IP Collateral granted, assigned or conveyed pursuant to the Agreement.

*[Remainder of this page intentionally left blank]*

IN WITNESS WHEREOF, Assignee has caused this Release of Intellectual Property Security Interest to be duly executed and delivered by its duly authorized representative as of the date first above written.

BANK ONE NA, as Agent

By: *Allan DeBuena*  
Name: *Allan DeBuena*  
Title: *VP*

**SCHEDULE 1**

**Registered Trademarks**

Mark	Country	Reg. Date	Reg.#
DIA-SOFT	U.S.	6/15/1999	2,253,071
FAB-AIR	U.S.	11/12/2002	2,650,690

**Pending Trademark Applications**

None

**Registered Patents**

Title	Country	Issue Date	Patent #
Rolling Head Diaphragm	U.S.	10/7/1997	5,673,607
Method for setup and molding of formed articles from thin coated fabrics	U.S.	10/30/2001	6,309,576

Signature page to Release of Intellectual Property Security Interest -- Diacom Corporation  
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